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SEMICONDUCTOR

FDME1024NZT Dual N-Channel PowerTrench[®] MOSFET **20 V, 3.8 A, 66 m**Ω

Features

- Max $r_{DS(on)}$ = 66 m Ω at V_{GS} = 4.5 V, I_D = 3.4 A
- Max $r_{DS(on)}$ = 86 m Ω at V_{GS} = 2.5 V, I_D = 2.9 A
- Max $r_{DS(on)}$ = 113 m Ω at V_{GS} = 1.8 V, I_D = 2.5 A
- Max r_{DS(on)} = 160 mΩ at V_{GS} = 1.5 V, I_D = 2.1 A
- Low profile: 0.55 mm maximum in the new package MicroFET 1.6x1.6 Thin
- Free from halogenated compounds and antimony oxides
- HBM ESD protection level > 1600 V (Note 3)
- RoHS Compliant



General Description

This device is designed specifically as a single package solution for dual switching requirement in cellular handset and other ultra-portable applications. It features two independent N-Channel MOSFETs with low on-state resistance for minimum conduction losses.

The MicroFET 1.6x1.6 Thin package offers exceptional thermal performance for it's physical size and is well suited to switching and linear mode applications.

Applications

- Baseband Switch
- Load Switch



MicroFET 1.6x1.6 Thin

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DS}	Drain to Source Voltage			20	V
V _{GS}	Gate to Source Voltage			±8	V
I _D	Drain Current -Continuous	T _A = 25 °C	(Note 1a)	3.8	٨
	-Pulsed			6	— A
P	Power Dissipation for Single Operation	T _A = 25 °C	(Note 1a)	1.4	14/
P _D	Power Dissipation for Single Operation	T _A = 25 °C	(Note 1b)	0.6	W
T _J , T _{STG}	Operating and Storage Junction Temperation	ature Range		-55 to +150	°C

Thermal Characteristics

$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Single Operation)	(Note 1a)	90	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Single Operation)	(Note 1b)	195	C/vv

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
4T	FDME1024NZT	MicroFET 1.6x1.6 Thin	7 "	8 mm	5000 units

July 2010

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		16		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 16 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 8 V, V_{DS} = 0 V$			±10	μA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, \ I_D = 250 \ \mu A$	0.4	0.7	1.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25 °C		-3		mV/°C
	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, \ I_D = 3.4 \text{ A}$		55	66	
		$V_{GS} = 2.5 \text{ V}, \ I_D = 2.9 \text{ A}$		68	86	mΩ
r _{DS(on)}		$V_{GS} = 1.8 \text{ V}, \ I_D = 2.5 \text{ A}$		85	113	
		$V_{GS} = 1.5 \text{ V}, \ I_D = 2.1 \text{ A}$		106	160	
		$V_{GS} = 4.5 \text{ V}, \ I_D = 3.4 \text{ A}, \ T_J = 125 \ ^\circ\text{C}$		76	112	
9 _{FS}	Forward Transconductance	$V_{DD} = 4.5 \text{ V}, \ \text{I}_{D} = 3.4 \text{ A}$		9		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	V 40.V.V. 0.V.		225	300	pF
C _{oss}	Output Capacitance	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		40	55	pF
C _{rss}	Reverse Transfer Capacitance			25	40	pF
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			4.5	10	ns
	, ,	—⊢		-		

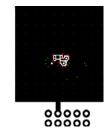
t _{d(on)}	Turn-On Delay Time		4.5	10	ns
t _r	Rise Time	V _{DD} = 10 V, I _D = 1 A,	2	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	15	27	ns
t _f	Fall Time		1.7	10	ns
Qg	Total Gate Charge	V 40.V.L 2.4.A	3	4.2	nC
Q _{gs}	Gate to Source Gate Charge	— V _{DD} = 10 V, I _D = 3.4 A, — V _{GS} = 4.5 V	0.4		nC
Q _{gd}	Gate to Drain "Miller" Charge		0.6		nC

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 0.9 A$ (No	ote 2)	0.7	1.2	V
t _{rr}	Reverse Recovery Time	I _E = 3.4 A, di/dt = 100 A/μs		8.5	17	ns
Q _{rr}	Reverse Recovery Charge	$F_{\rm F} = 3.4 \text{Å}, \text{di/dt} = 100 \text{Å/} \mu \text{S}$		1.4	10	nC

NOTES:

R_{θJA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{θJC} is guaranteed by design while R_{θCA} is determined by the user's board design.



2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

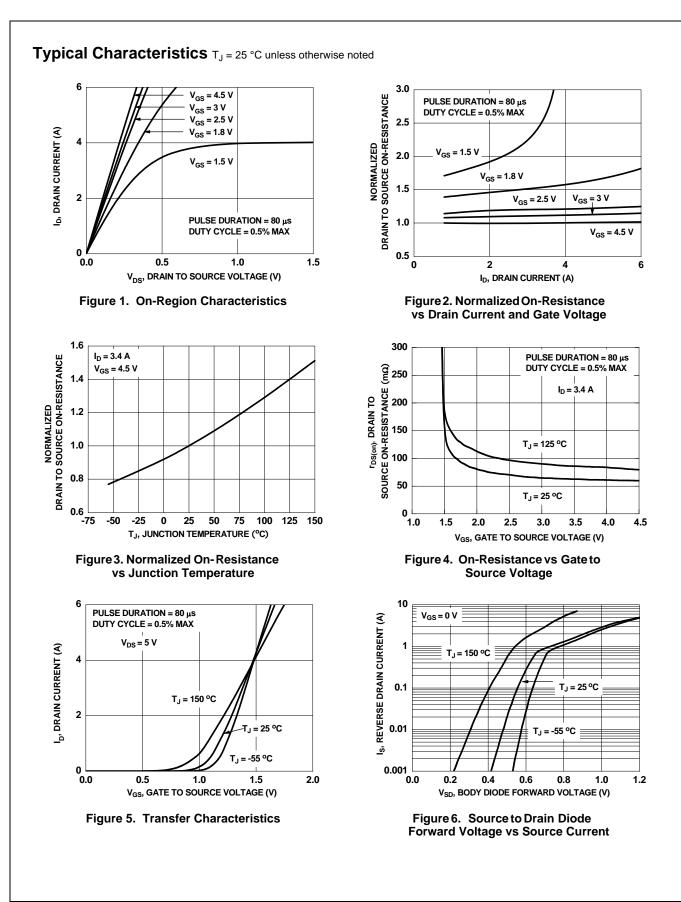
a. 90 °C/W when mounted on a 1 in² pad of 2 oz copper.

3. The diode connected between the gate and source serves only as protection ESD. No gate overvoltage rating is implied.

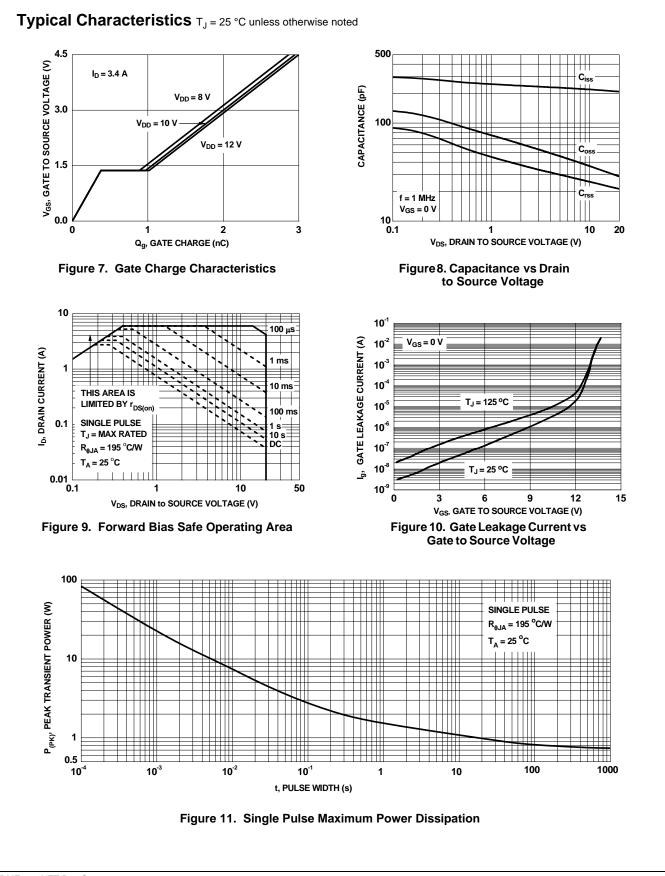


b. 195 °C/W when mounted on a minimum pad of 2 oz copper.

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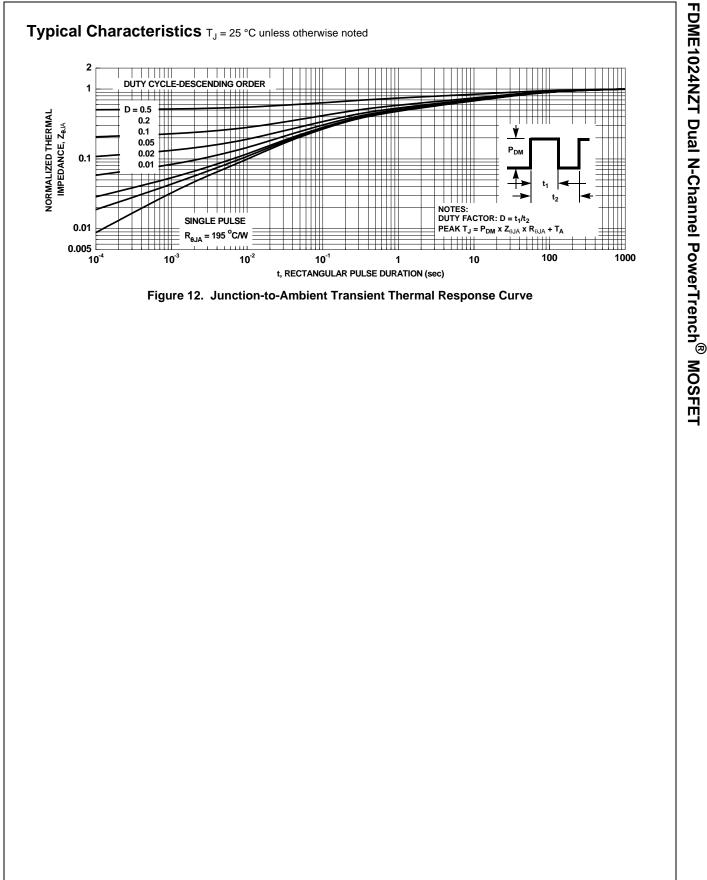
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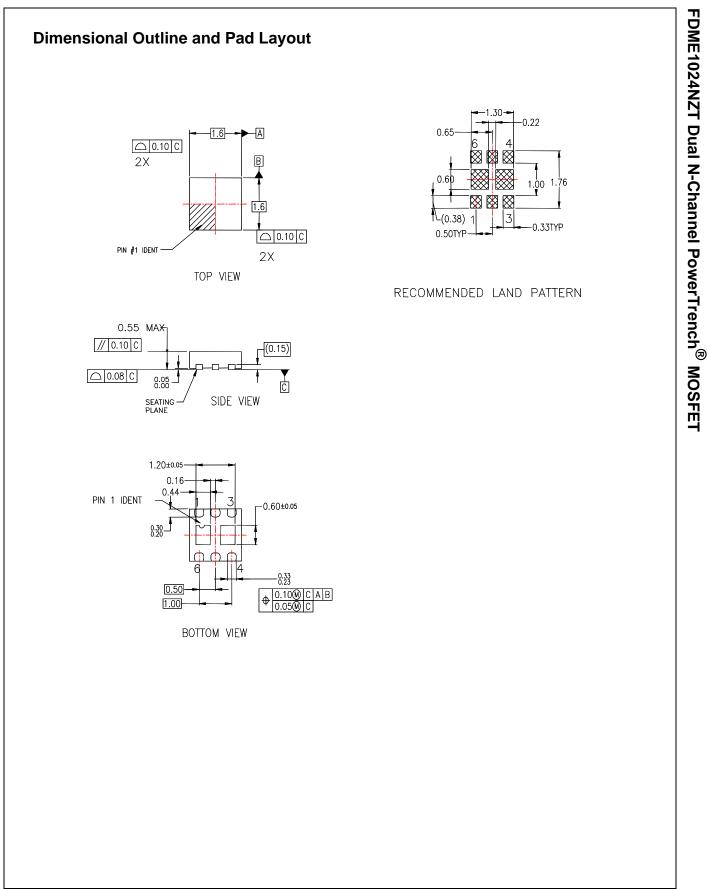


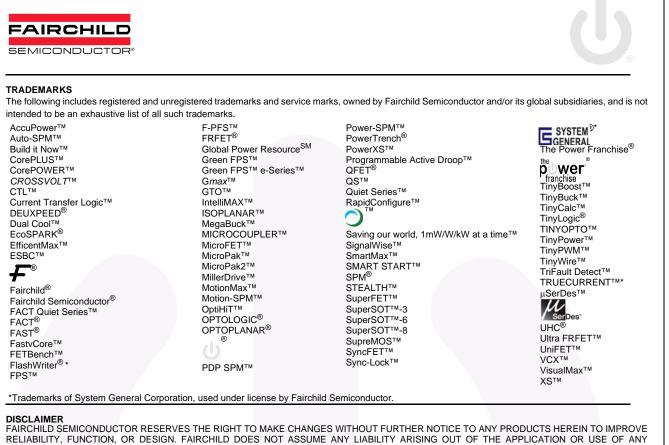
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